MAX17543

4.5V–42V, 2.5A, High-Efficiency, Synchronous Step-Down DC-DC Converter with Internal Compensation

General Description

The MAX17543 high-efficiency, high-voltage, synchronous step-down DC-DC converter with integrated MOSFETs operates over a 4.5V to 42V input. The converter can deliver up to 2.5A and generates output voltages from 0.9V up to 0.9 \times V_{IN}. The feedback (FB) voltage is accurate to within ±1.1% over -40°C to +125°C.

The MAX17543 uses peak current-mode control. The device can be operated in the pulse-width modulation (PWM), pulse-frequency modulation (PFM), or discontinuous conduction mode (DCM) control schemes.

The device is available in a 20-pin (4mm x 4mm) TQFN package. Simulation models are available.

Applications

- Industrial Power Supplies
- Distributed Supply Regulation
- High-Voltage Single-Board Systems
- Base Station Power Supply
- General-Purpose Point-of-Load

Ordering Information appears at end of data sheet.

Benefits and Features

- Reduces External Components and Total Cost
  - No Schottky—Synchronous Operation
  - Internal Compensation for Any Output Voltage
  - Built-In Soft-Start
  - All-Ceramic Capacitors, Compact Layout
- Reduces Number of DC-DC Regulators to Stock
  - Wide 4.5V to 42V Input
  - Adjustable 0.9V to 0.9 \times V_{IN} Output
  - 100kHz to 2.2MHz Adjustable Switching Frequency with External Synchronization
- Reduces Power Dissipation
  - Peak Efficiency >90%
  - PFM/DCM Enables Enhanced Light-Load Efficiency
  - 2.8μA Shutdown Current
- Operates Reliably in Adverse Industrial Environments
  - Peak Current-Limit Protection
  - Built-In Output Voltage Monitoring with RESET
  - Programmable EN/UVLO Threshold
  - Monotonic Startup into Prebiased Load
  - Overtemperature Protection
  - High Industrial -40°C to +125°C Ambient Operating Temperature Range/-40°C to +150°C Junction Temperature Range

Typical Application Circuit—5V, 500kHz Switching Frequency
MAX17543

4.5V–42V, 2.5A, High-Efficiency, Synchronous Step-Down DC-DC Converter with Internal Compensation

Absolute Maximum Ratings

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Symbol</th>
<th>Conditions</th>
<th>Min</th>
<th>Typ</th>
<th>Max</th>
<th>Units</th>
</tr>
</thead>
<tbody>
<tr>
<td>Input Voltage Range</td>
<td>IN</td>
<td></td>
<td>4.5</td>
<td>42</td>
<td>V</td>
<td></td>
</tr>
<tr>
<td>Input Shutdown Current</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Input Quiescent Current</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>ENABLE/UVLO (EN/UVLO)</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>EN/UVLO Threshold</td>
<td></td>
<td></td>
<td>1.19</td>
<td>1.215</td>
<td>1.26</td>
<td>V</td>
</tr>
<tr>
<td>EN/UVLO Input Leakage Current</td>
<td></td>
<td></td>
<td>-50</td>
<td>0</td>
<td>+50</td>
<td>nA</td>
</tr>
<tr>
<td>LDO</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>VCC Output Voltage Range</td>
<td></td>
<td></td>
<td>6V &lt; VIN &lt; 42V, IVCC = 1mA</td>
<td>4.75</td>
<td>5</td>
<td>5.25</td>
</tr>
<tr>
<td>VCC Current Limit</td>
<td></td>
<td>1mA ≤ IVCC ≤ 25mA</td>
<td>26.5</td>
<td>54</td>
<td>100</td>
<td>mA</td>
</tr>
<tr>
<td>VCC Dropout</td>
<td></td>
<td>VIN = 4.5V, IVCC = 20mA</td>
<td>4.2</td>
<td></td>
<td></td>
<td>V</td>
</tr>
<tr>
<td>VCC UVLO</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Junction temperature greater than +125°C degrades operating lifetimes.

Package Thermal Characteristics (Note 1)

TQFN

Junction-to-Ambient Thermal Resistance (θJA) ........ 33°C/W
Junction-to-Case Thermal Resistance (θJC) .......... 2°C/W

Note 1: Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to www.maximintegrated.com/thermal-tutorial.

Electrical Characteristics

(VIN = VEN/UVLO = 24V, RRT = 40.2kΩ (500kHz), CVC = 2.2μF, VPGND = VSGND = VMODE = VSYNC = 0V, LX = SS = RESET = open, VBST to VIN = 5V, VFB = 1V, T = -40°C to +125°C, unless otherwise noted. Typical values are at T = +25°C. All voltages are referenced to SGND, unless otherwise noted.) (Note 2)

<table>
<thead>
<tr>
<th>Parameter</th>
<th>Symbol</th>
<th>Conditions</th>
<th>Min</th>
<th>Typ</th>
<th>Max</th>
<th>Units</th>
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</thead>
</table>

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**Electrical Characteristics (continued)**

\( V_{IN} = V_{EN/UVLO} = 24V, R_{RT} = 40.2\,\text{k}\Omega \) (500kHz), \( C_{VCC} = 2.2\,\mu\text{F}, V_{PGND} = V_{SGND} = V_{MODE} = V_{SYNC} = 0V, L_X = SS = \text{RESET} = \text{open}, V_{BST} \text{ to } V_{LX} = 5V, V_{FB} = 1V, T_A = -40^\circ C \text{ to } +125^\circ C \), unless otherwise noted. Typical values are at \( T_A = +25^\circ C \). All voltages are referenced to SGND, unless otherwise noted. (Note 2)

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>SYMBOL</th>
<th>CONDITIONS</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
<th>UNITS</th>
</tr>
</thead>
<tbody>
<tr>
<td><strong>POWER MOSFET AND BST DRIVER</strong></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>High-Side nMOS On-Resistance</td>
<td>( R_{DS-ONH} )</td>
<td>( I_{LX} = 0.3A )</td>
<td>165</td>
<td>325</td>
<td>mΩ</td>
<td></td>
</tr>
<tr>
<td>Low-Side nMOS On-Resistance</td>
<td>( R_{DS-ONL} )</td>
<td>( I_{LX} = 0.3A )</td>
<td>80</td>
<td>150</td>
<td>mΩ</td>
<td></td>
</tr>
<tr>
<td>LX Leakage Current</td>
<td>( I_{LX_LKG} )</td>
<td>( V_{LX} = V_{IN} - 1V, V_{LX} = V_{PGND} + 1V, T_A = +25^\circ C )</td>
<td>-2</td>
<td>2</td>
<td>µA</td>
<td></td>
</tr>
<tr>
<td><strong>SOFT-START (SS)</strong></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Charging Current</td>
<td>( I_{SS} )</td>
<td>( V_{SS} = 0.5V )</td>
<td>4.7</td>
<td>5</td>
<td>5.3</td>
<td>µA</td>
</tr>
<tr>
<td><strong>FEEDBACK (FB)</strong></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>FB Regulation Voltage</td>
<td>( V_{FB_REG} )</td>
<td>MODE = SGND or MODE = ( V_{CC} )</td>
<td>0.89</td>
<td>0.9</td>
<td>0.91</td>
<td>V</td>
</tr>
<tr>
<td></td>
<td></td>
<td>MODE = OPEN</td>
<td>0.89</td>
<td>0.915</td>
<td>0.936</td>
<td>V</td>
</tr>
<tr>
<td>FB Input Bias Current</td>
<td>( I_{FB} )</td>
<td>( 0 &lt; V_{FB} &lt; 1V, T_A = +25^\circ C )</td>
<td>-50</td>
<td>+50</td>
<td>nA</td>
<td></td>
</tr>
<tr>
<td><strong>MODE</strong></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>MODE Threshold</td>
<td>( V_{M-DCM} )</td>
<td>MODE = ( V_{CC} ) (DCM mode)</td>
<td>( V_{CC} - 1.6 )</td>
<td>V</td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>( V_{M-PFM} )</td>
<td>MODE = open (PFM mode)</td>
<td>( V_{CC} / 2 )</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>( V_{M-PWM} )</td>
<td>MODE = GND (PWM mode)</td>
<td>1.4</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td><strong>CURRENT LIMIT</strong></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Peak Current-Limit Threshold</td>
<td>( I_{PEAK_LIMIT} )</td>
<td></td>
<td>3.2</td>
<td>3.7</td>
<td>4.3</td>
<td>A</td>
</tr>
<tr>
<td>Runaway Current-Limit Threshold</td>
<td>( I_{RUNAWAY_LIMIT} )</td>
<td></td>
<td>3.7</td>
<td>4.3</td>
<td>5</td>
<td>A</td>
</tr>
<tr>
<td>Valley Current-Limit Threshold</td>
<td>( I_{SINK_LIMIT} )</td>
<td>MODE = open/( V_{CC} )</td>
<td>-0.16</td>
<td>0</td>
<td>+0.16</td>
<td>A</td>
</tr>
<tr>
<td>PFM Current-Limit Threshold</td>
<td>( I_{PFM} )</td>
<td>MODE = open</td>
<td>0.6</td>
<td>0.75</td>
<td>0.9</td>
<td>A</td>
</tr>
<tr>
<td><strong>RT AND SYNC</strong></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Switching Frequency</td>
<td>( f_{SW} )</td>
<td>( R_{RT} = 210k\Omega )</td>
<td>90</td>
<td>100</td>
<td>110</td>
<td>kHz</td>
</tr>
<tr>
<td></td>
<td></td>
<td>( R_{RT} = 102k\Omega )</td>
<td>180</td>
<td>200</td>
<td>220</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>( R_{RT} = 40.2k\Omega )</td>
<td>475</td>
<td>500</td>
<td>525</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>( R_{RT} = 8.06k\Omega )</td>
<td>1950</td>
<td>2200</td>
<td>2450</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td>( R_{RT} = \text{open} )</td>
<td>460</td>
<td>500</td>
<td>540</td>
<td></td>
</tr>
<tr>
<td>SYNC Frequency Capture Range</td>
<td>( f_{SW} ) \text{ set by } R_{RT}</td>
<td>1.1 \times f_{SW}</td>
<td>1.4 \times f_{SW}</td>
<td>kHz</td>
<td></td>
<td></td>
</tr>
<tr>
<td>SYNC Pulse Width</td>
<td></td>
<td></td>
<td>50</td>
<td>ns</td>
<td></td>
<td></td>
</tr>
<tr>
<td>SYNC Threshold</td>
<td>( V_{IH} )</td>
<td>2.1</td>
<td>V</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td></td>
<td>( V_{IL} )</td>
<td>0.8</td>
<td>V</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>FB Undervoltage Trip Level to Cause Hiccup</td>
<td>( V_{FB-HICF} )</td>
<td></td>
<td>0.56</td>
<td>0.58</td>
<td>0.65</td>
<td>V</td>
</tr>
</tbody>
</table>

(maximintegrated.com)
## Electrical Characteristics (continued)

$(V_{\text{IN}} = V_{\text{EN/UVLO}} = 24\, \text{V}, R_{\text{RT}} = 40.2\, \Omega \, (500\, \text{kHz}), C_{\text{VCC}} = 2.2\, \mu\text{F}, V_{\text{PGND}} = V_{\text{SGND}} = V_{\text{MODE}} = V_{\text{SYNC}} = 0\, \text{V}, L_X = SS = \text{RESET} = \text{open}, V_{\text{BST}} \to V_{LX} = 5\, \text{V}, V_{\text{FB}} = 1\, \text{V}, T_A = -40^\circ\text{C} \, \text{to} \, +125^\circ\text{C}, \text{unless otherwise noted}. \text{Typical values are at } T_A = +25^\circ\text{C}. \text{All voltages are referenced to SGND, unless otherwise noted.}) \text{ (Note 2)}$

<table>
<thead>
<tr>
<th>PARAMETER</th>
<th>SYMBOL</th>
<th>CONDITIONS</th>
<th>MIN</th>
<th>TYP</th>
<th>MAX</th>
</tr>
</thead>
<tbody>
<tr>
<td>Hiccup Timeout</td>
<td>$t_{\text{ON-MIN}}$</td>
<td>(Note 3)</td>
<td>32,768</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Minimum On-Time</td>
<td></td>
<td></td>
<td>135</td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td>Minimum Off-Time</td>
<td>$t_{\text{OFF-MIN}}$</td>
<td></td>
<td>140</td>
<td>160</td>
<td>ns</td>
</tr>
<tr>
<td>LX Dead Time</td>
<td></td>
<td></td>
<td>5</td>
<td>ns</td>
<td></td>
</tr>
<tr>
<td><strong>RESET</strong></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>RESET Output Level Low</td>
<td>$I_{\text{RESET}}$</td>
<td>$T_{\text{A}} = T_{\text{J}} = +25^\circ\text{C}, V_{\text{RESET}} = 5.5, \text{V}$</td>
<td>0.4</td>
<td>V</td>
<td></td>
</tr>
<tr>
<td>RESET Output Leakage Current</td>
<td></td>
<td></td>
<td>-0.1</td>
<td>+0.1</td>
<td>µA</td>
</tr>
<tr>
<td>FB Threshold for RESET Assertion</td>
<td>$V_{\text{FB-OKF}}$</td>
<td>$V_{\text{FB}} \text{ falling}$</td>
<td>90.5</td>
<td>92</td>
<td>94.6</td>
</tr>
<tr>
<td>FB Threshold for RESET Deassertion</td>
<td>$V_{\text{FB-OKR}}$</td>
<td>$V_{\text{FB}} \text{ rising}$</td>
<td>93.8</td>
<td>95</td>
<td>97.8</td>
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<tr>
<td>RESET Deassertion Delay After FB Reaches 95% Regulation</td>
<td></td>
<td></td>
<td>1024</td>
<td></td>
<td>Cycles</td>
</tr>
<tr>
<td><strong>THERMAL SHUTDOWN</strong></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Thermal Shutdown Threshold</td>
<td></td>
<td>Temperature rising</td>
<td>165</td>
<td></td>
<td>ºC</td>
</tr>
<tr>
<td>Thermal Shutdown Hysteresis</td>
<td></td>
<td></td>
<td>10</td>
<td></td>
<td>ºC</td>
</tr>
</tbody>
</table>

**Note 2:** All limits are 100% tested at $+25^\circ\text{C}$. Limits over temperature are guaranteed by design.

**Note 3:** See the Overcurrent Protection/Hiccup Mode section for more details.
Typical Operating Characteristics

(V_{IN} = V_{EN/UVLO} = 24V, V_{PGND} = V_{SGND} = 0V, C_{VIN} = C_{VCC} = 2.2\mu F, C_{BST} = 0.1\mu F, C_{SS} = 5600pF, RT = MODE = open, T_A = -40°C to +125°C, unless otherwise noted. Typical values are at T_A = +25°C. All voltages are referenced to GND, unless otherwise noted.)

5V OUTPUT, PWM MODE, FIGURE 4a CIRCUIT,
EFFICIENCY VS. LOAD CURRENT

3.3V OUTPUT, PWM MODE, FIGURE 4b CIRCUIT,
EFFICIENCY VS. LOAD CURRENT

5V OUTPUT, PFM MODE, FIGURE 4a CIRCUIT,
EFFICIENCY VS. LOAD CURRENT

3.3V OUTPUT, PFM MODE, FIGURE 4b CIRCUIT,
EFFICIENCY VS. LOAD CURRENT

5V OUTPUT, PWM MODE, FIGURE 4a CIRCUIT,
LOAD AND LINE REGULATION

3.3V OUTPUT, PWM MODE, FIGURE 4b CIRCUIT,
LOAD AND LINE REGULATION

5V OUTPUT, PFM MODE, FIGURE 4a CIRCUIT,
LOAD AND LINE REGULATION
Typical Operating Characteristics (continued)

\( V_{IN} = V_{EN/UVLO} = 24V, V_{PGND} = V_{SGND} = 0V, C_{VCC} = 2.2\mu F, C_{BST} = 0.1\mu F, C_{SS} = 5600pF, RT = MODE = \text{open}, T_A = -40^\circ C \text{ to } +125^\circ C, \text{ unless otherwise noted. Typical values are at } T_A = +25^\circ C. \text{ All voltages are referenced to GND, unless otherwise noted.} \)
Typical Operating Characteristics (continued)

\( V_{\text{IN}} = V_{\text{EN/UVLO}} = 24\text{V}, V_{\text{PGND}} = V_{\text{SGND}} = 0\text{V}, C_{\text{VIN}} = C_{\text{VCC}} = 2.2\mu\text{F}, C_{\text{BST}} = 0.1\mu\text{F}, C_{\text{SS}} = 5600\text{pF}, RT = \text{MODE} = \text{open}, T_A = -40°C \text{ to } +125°C, \text{ unless otherwise noted. Typical values are at } T_A = +25°C. \text{ All voltages are referenced to GND, unless otherwise noted.} \)
Typical Operating Characteristics (continued)

(V_{IN} = V_{EN/UVLO} = 24V, V_{PGND} = V_{SGND} = 0V, C_{VIN} = C_{VCC} = 2.2\mu F, C_{BST} = 0.1\mu F, C_{SS} = 5600pF, RT = MODE = open, T_{A} = -40°C to +125°C, unless otherwise noted. Typical values are at T_{A} = +25°C. All voltages are referenced to GND, unless otherwise noted.)
**Typical Operating Characteristics (continued)**

(V\text{IN} = V\text{EN/LVLO} = 24\text{V}, V\text{PGND} = V\text{SGND} = 0\text{V}, C\text{VIN} = C\text{VCC} = 2.2\text{µF}, C\text{BST} = 0.1\text{µF}, C\text{SS} = 5600\text{pF}, RT = MODE = open, T\text{A} = -40°C to +125°C, unless otherwise noted. Typical values are at T\text{A} = +25°C. All voltages are referenced to GND, unless otherwise noted.)

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**5V OUTPUT, OVERLOAD PROTECTION, FIGURE 4a CIRCUIT**

- V\text{OUT} 500mV/div
- I\text{OUT} 1A/div
- 20ms/div

**5V OUTPUT, APPLICATION OF EXTERNAL CLOCK AT 700kHz, FIGURE 4a CIRCUIT**

- V\text{Lx} 10V/div
- V\text{SYNC} 2V/div
- 2µs/div

**5V OUTPUT, 2.5A LOAD CURRENT BODE PLOT, FIGURE 4a CIRCUIT**

- GAIN (dB)
- PHASE (°)

**5V OUTPUT, 2.5A LOAD CURRENT BODE PLOT, FIGURE 4b CIRCUIT**

- GAIN (dB)
- PHASE (°)

**MAX17543, 5V OUTPUT, APPLICATION OF EXTERNAL CLOCK AT 700kHz, FIGURE 4a CIRCUIT, CONDUCTED EMI CURVE**

- QUASI-PEAK LIMIT
- AVERAGE LIMIT
- PEAK EMISSIONS
- AVERAGE EMISSIONS

Measured on the MAX17543EVKITB with input filter – C\text{IN} = 4.7\text{µF}, L\text{IN} = 10\text{µH}, the input capacitor for the MAX17543: 4.7\text{µF}.
## Pin Configuration

![MAX17543 Pin Configuration Diagram](image)

* EXPOSED PAD (CONNECT TO GROUND).

## Pin Description

<table>
<thead>
<tr>
<th>PIN</th>
<th>NAME</th>
<th>FUNCTION</th>
</tr>
</thead>
<tbody>
<tr>
<td>1–3</td>
<td>VIN</td>
<td>Power Supply Input. 4.5V to 42V input supply range. Connect the VIN pins together. Decouple to PGND with a 2.2µF capacitor; place the capacitor close to the VIN and PGND pins. Refer to the MAX17543 EV kit data sheet for a layout example.</td>
</tr>
<tr>
<td>4</td>
<td>EN/UVLO</td>
<td>Enable/Undervoltage Lockout. Drive EN/UVLO high to enable the output voltage. Connect to the center of the resistor-divider between VIN and SGND to set the input voltage at which the device turns on. Pull up to VIN for always-on operation.</td>
</tr>
<tr>
<td>5</td>
<td>RESET</td>
<td>Open-Drain RESET Output. The RESET output is driven low if FB drops below 92% of its set value. RESET goes high 1024 clock cycles after FB rises above 95% of its set value.</td>
</tr>
<tr>
<td>6</td>
<td>SYNC</td>
<td>The device can be synchronized to an external clock using this pin. See the External Frequency Synchronization section for more details.</td>
</tr>
<tr>
<td>7</td>
<td>SS</td>
<td>Soft-Start Input. Connect a capacitor from SS to SGND to set the soft-start time.</td>
</tr>
<tr>
<td>8</td>
<td>CF</td>
<td>At switching frequencies lower than 500kHz, connect a capacitor from CF to FB. Leave CF open if switching frequency is equal to, or greater than, 500kHz. See the Loop Compensation section for more details.</td>
</tr>
<tr>
<td>9</td>
<td>FB</td>
<td>Feedback Input. Connect FB to the center tap of an external resistor-divider from the output to GND to set the output voltage. See the Adjusting Output Voltage section for more details.</td>
</tr>
<tr>
<td>10</td>
<td>RT</td>
<td>Connect a resistor from RT to SGND to set the regulator’s switching frequency. Leave RT open for the default 500kHz frequency. See the Setting the Switching Frequency (RT) section for more details.</td>
</tr>
<tr>
<td>11</td>
<td>MODE</td>
<td>MODE pin configures the device to operate either in PWM, PFM, or DCM modes of operation. Leave MODE unconnected for PFM operation (pulse-skipping at light loads). Connect MODE to SGND for constant-frequency PWM operation at all loads. Connect MODE to VCC for DCM operation. See the MODE Setting section for more details.</td>
</tr>
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Pin Description (continued)

<table>
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<tr>
<th>PIN</th>
<th>NAME</th>
<th>FUNCTION</th>
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<tr>
<td>12</td>
<td>V_{CC}</td>
<td>5V LDO Output. Bypass V_{CC} with 2.2µF ceramic capacitance to SGND.</td>
</tr>
<tr>
<td>13</td>
<td>SGND</td>
<td>Analog Ground</td>
</tr>
<tr>
<td>14–16</td>
<td>PGND</td>
<td>Power Ground. Connect the PGND pins externally to the power ground plane. Connect the SGND and PGND pins together at the ground return path of the V_{CC} bypass capacitor. Refer to the MAX17543 EV kit data sheet for a layout example.</td>
</tr>
<tr>
<td>17–19</td>
<td>LX</td>
<td>Switching Node. Connect LX pins to the switching-side of the inductor. Refer to the MAX17543 EV kit data sheet for a layout example.</td>
</tr>
<tr>
<td>20</td>
<td>BST</td>
<td>Boost Flying Capacitor. Connect a 0.1µF ceramic capacitor between BST and LX.</td>
</tr>
<tr>
<td>—</td>
<td>EP</td>
<td>Exposed Pad. Connect to the SGND pin. Connect to a large copper plane below the IC to improve heat dissipation capability. Add thermal vias below the exposed pad. Refer to the MAX17543 EV kit data sheet for a layout example.</td>
</tr>
</tbody>
</table>

Block Diagram

![Block Diagram of MAX17543](image-url)
Detailed Description
The MAX17543 high-efficiency, high-voltage, synchronously-rectified step-down converter with dual integrated MOSFETs operates over a 4.5V to 42V input. It delivers up to 2.5A and 0.9V to 90%V_{IN} output voltage. Built-in compensation across the output voltage range eliminates the need for external components. The feedback (FB) regulation accuracy over -40°C to +125°C is ±1.1%.

The device features a peak-current-mode-control architecture. An internal transconductance error amplifier produces an integrated error voltage at an internal node, which sets the duty cycle using a PWM comparator, a high-side current-sense amplifier, and a slope-compensation generator. At each rising-edge of the clock, the high-side MOSFET turns on and remains on until either the appropriate or maximum duty cycle is reached, or the peak current limit is detected. During the high-side MOSFET’s on-time, the inductor current ramps up. During the second-half of the switching cycle, the high-side MOSFET turns off and the low-side MOSFET turns on. The inductor releases the stored energy as its current ramps down and provides current to the output.

The device features a MODE pin that can be used to operate the device in PWM, PFM, or DCM control schemes. The device integrates adjustable-input undervoltage lockout, adjustable soft-start, open RESET, and external frequency-synchronization features.

Mode Selection (MODE)
The logic state of the MODE pin is latched when V_{CC} and EN/UVLO voltages exceed the respective UVLO rising thresholds and all internal voltages are ready to allow LX switching. If the MODE pin is open at power-up, the device operates in PWM mode at light loads. If the MODE pin is grounded at power-up, the device operates in constant-frequency PWM mode at all loads. Finally, if the MODE pin is connected to V_{CC} at power-up, the device operates in constant-frequency DCM mode at light loads. State changes on the MODE pin are ignored during normal operation.

PWM Mode Operation
In PWM mode, the inductor current is allowed to go negative. PWM operation provides constant frequency operation at all loads, and is useful in applications sensitive to switching frequency. However, the PWM mode of operation gives lower efficiency at light loads when compared to PFM and DCM modes of operation.

PFM Mode Operation
The PFM mode of operation disables negative inductor current and also skips pulses at light loads for high efficiency. In PFM mode, the inductor current is forced to a fixed peak of 750mA every clock cycle until the output rises to 102.3% of the nominal voltage. Once the output reaches 102.3% of the nominal voltage, both the high-side and low-side FETs are turned off and the device enters hibernation mode until the load discharges the output to 101.1% of the nominal voltage. Most of the internal blocks are turned off in hibernation mode to save quiescent current. After the output falls below 101.1% of the nominal voltage, the device comes out of hibernation mode, turns on all internal blocks, and again commences the process of delivering pulses of energy to the output until it reaches 102.3% of the nominal output voltage. The advantage of PFM mode is higher efficiency at light loads due to lower quiescent current drawn from supply. The disadvantage is that the output voltage ripple is higher than in the PWM or DCM modes of operation, and the switching frequency is not constant at light loads.

DCM Mode Operation
The DCM mode of operation features constant-frequency operation down to lighter loads than PFM mode by disabling negative inductor current at light loads instead of skipping pulses. DCM operation offers efficiency performance that lies between the PWM and PFM modes.

Linear Regulator (V_{CC})
An internal linear regulator (V_{CC}) provides a 5V nominal supply to power the internal blocks and the low-side MOSFET driver. The output of the linear regulator (V_{CC}) should be bypassed with a 2.2µF ceramic capacitor to SGND. The device employs an undervoltage lockout circuit that disables the internal linear regulator when V_{CC} falls below 3.8V (typ).

Setting the Switching Frequency (RT)
The switching frequency of the device can be programmed from 100kHz to 2.2MHz by using a resistor connected from the RT pin to SGND. The switching frequency (f_{SW}) is related to the resistor connected at the RT pin (R_{RT}) by the following equation:

$$R_{RT} = \frac{21 \times 10^3}{f_{SW}} - 1.7$$

where R_{RT} is in kΩ and f_{SW} is in kHz. Leaving the RT pin open causes the device to operate at the default switching frequency of 500kHz. See Table 1 for RT resistor values for a few common switching frequencies. To operate the MAX17543 at switching frequencies lower than 200kHz, an
R-C network has to be connected in parallel to the resistor connected from RT to SGND, as shown in Figure 1. The values of the components R8 and C13 are 90.9kΩ and 220pF, respectively.

### Operating Input Voltage Range

The minimum and maximum operating input voltages for a given output voltage should be calculated as follows:

\[
V_{\text{IN(MIN)}} = \frac{V_{\text{OUT}} + (I_{\text{OUT(MAX)}} \times (R_{\text{DCR}} + 0.15))}{1 - (f_{\text{SW(MAX)}} \times t_{\text{OFF(MAX)}})} + (I_{\text{OUT(MAX)}} \times 0.175)
\]

\[
V_{\text{IN(MAX)}} = \frac{V_{\text{OUT}}}{f_{\text{SW(MAX)}} \times t_{\text{ON(MIN)}}}
\]

where \(V_{\text{OUT}}\) is the steady-state output voltage, \(I_{\text{OUT(MAX)}}\) is the maximum load current, \(R_{\text{DCR}}\) is the DC resistance of the inductor, \(f_{\text{SW(MAX)}}\) is the maximum switching frequency, \(t_{\text{OFF(MAX)}}\) is the worst-case minimum switch off-time (160ns), and \(t_{\text{ON(MIN)}}\) is the worst-case minimum switch on-time (135ns).

### Overcurrent Protection/Hiccup Mode

The MAX17543 is provided with a robust overcurrent protection scheme that protects the device under overload and output short-circuit conditions. A cycle-by-cycle peak current limit turns off the high-side MOSFET whenever the high-side switch current exceeds an internal limit of 3.7A (typ). A runaway current limit on the high-side switch current at 4.3A (typ) protects the device under high input voltage, short-circuit conditions when there is insufficient output voltage available to restore the inductor current that was built up during the ON period of the step-down converter. One occurrence of runaway current limit triggers a hiccup mode. In addition, if, due to a fault condition, feedback voltage drops to 0.58V (typ) any time after soft-start is complete, hiccup mode is triggered. In hiccup mode, the converter is protected by suspending switching for a hiccup timeout period of 32,768 clock cycles. Once the hiccup timeout period expires, soft-start is attempted again. Note that when soft-start is attempted under an overload condition, if the feedback voltage does not exceed 0.58V, the device switches at half the programmed switching frequency. Hiccup mode of operation ensures low power dissipation under output short-circuit conditions.

### RESET Output

The device includes a \(\text{RESET}\) comparator to monitor the output voltage. The open-drain \(\text{RESET}\) output requires an external pullup resistor. \(\text{RESET}\) goes high (high impedance) 1024 switching cycles after the regulator output increases above 95% of the designed nominal regulated voltage. \(\text{RESET}\) goes low when the regulator output voltage drops to below 92% of the nominal regulated voltage. \(\text{RESET}\) also goes low during thermal shutdown.

### Prebiased Output

When the device starts into a prebiased output, both the high-side and low-side switches are turned off so that the converter does not sink current from the output. High-side and low-side switches do not start switching until the PWM comparator commands the first PWM pulse, at which point switching commences. The output voltage is then smoothly ramped up to the target value in alignment with the internal reference.
Thermal-Shutdown Protection
Thermal-shutdown protection limits total power dissipation in the device. When the junction temperature of the device exceeds +165ºC, an on-chip thermal sensor shuts down the device, allowing it to cool. The thermal sensor turns the device on again after the junction temperature cools by 10ºC. Soft-start resets during thermal shutdown. Carefully evaluate the total power dissipation (see the Power Dissipation section) to avoid unwanted triggering of the thermal shutdown in normal operation.

Applications Information
Input Capacitor Selection
The input filter capacitor reduces peak currents drawn from the power source and reduces noise and voltage ripple on the input caused by the circuit’s switching. The input capacitor RMS current requirement (IRMS) is defined by the following equation:

\[ I_{\text{RMS}} = I_{\text{OUT(MAX)}} \times \sqrt{\frac{V_{\text{OUT}} \times (V_{\text{IN}} - V_{\text{OUT}})}{V_{\text{IN}}}} \]

where, \( I_{\text{OUT(MAX)}} \) is the maximum load current. IRMS has a maximum value when the input voltage equals twice the output voltage (\( V_{\text{IN}} = 2 \times V_{\text{OUT}} \)), so \( I_{\text{RMS(MAX)}} = I_{\text{OUT(MAX)}}/2 \).

Choose an input capacitor that exhibits less than +10ºC temperature rise at the RMS input current for optimal long-term reliability. Use low-ESR ceramic capacitors with high-ripple-current capability at the input. X7R capacitors are recommended in industrial applications for their temperature stability. Calculate the input capacitance using the following equation:

\[ C_{\text{IN}} = \frac{I_{\text{OUT(MAX)}} \times D \times (1-D)}{\eta \times f_{\text{SW}} \times \Delta V_{\text{IN}}} \]

where \( D = V_{\text{OUT}}/V_{\text{IN}} \) is the duty ratio of the controller, \( f_{\text{SW}} \) is the switching frequency, \( \Delta V_{\text{IN}} \) is the allowable input voltage ripple, and \( \eta \) is the efficiency.

In applications where the source is located some distance from the device input, an electrolytic capacitor should be added in parallel to the ceramic capacitor to provide necessary damping for potential oscillations caused by the inductance of the longer input power path and input ceramic capacitor.

Inductor Selection
Three key inductor parameters must be specified for operation with the device: inductance value (L), inductor saturation current (ISAT), and DC resistance (RDCR). The switching frequency and output voltage determine the inductor value as follows:

\[ L = \frac{V_{\text{OUT}}}{f_{\text{SW}}} \]

where \( V_{\text{OUT}} \) and \( f_{\text{SW}} \) are nominal values.

Select a low-loss inductor closest to the calculated value with acceptable dimensions and having the lowest possible DC resistance. The saturation current rating (ISAT) of the inductor must be high enough to ensure that saturation can occur only above the peak current-limit value of 3.7A.

Output Capacitor Selection
X7R ceramic output capacitors are preferred due to their stability over temperature in industrial applications. The output capacitors are usually sized to support a step load of 50% of the maximum output current in the application, such that output voltage deviation is contained to 3% of nominal output voltage. The minimum required output capacitance can be calculated as follows:

\[ C_{\text{OUT}} = \frac{5.5}{(f_{C} \times V_{\text{OUT}})} \]

where \( C_{\text{OUT}} \) is in Farad and \( f_{C} \) is the target closed-loop crossover frequency in Hz. Select \( f_{C} \) to be 1/9th of \( f_{\text{SW}} \) if the switching frequency is less than or equal to 500kHz. If the switching frequency is more than 500kHz, select \( f_{C} \) to be 55kHz.

Derating of ceramic capacitors with DC-voltage must be considered while selecting the output capacitor. Derating curves are available from all major ceramic capacitor vendors.

Soft-Start Capacitor Selection
The device implements adjustable soft-start operation to reduce inrush current. A capacitor connected from the SS pin to SGND programs the soft-start time. The selected output capacitance \( (C_{\text{SEL}}) \) and the output voltage \( (V_{\text{OUT}}) \) determine the minimum required soft-start capacitor as follows:

\[ C_{\text{SS}} \geq 28 \times 10^{-6} \times C_{\text{SEL}} \times V_{\text{OUT}} \]

The soft-start time \( (t_{SS}) \) is related to the capacitor connected at SS \( (C_{\text{SS}}) \) by the following equation:

\[ t_{SS} = \frac{C_{\text{SS}}}{5.55 \times 10^{-6}} \]

For example, to program a 1ms soft-start time, a 5.6nF capacitor should be connected from the SS pin to SGND.
Setting the Input Undervoltage-Lockout Level

The device offers an adjustable input undervoltage-lockout level. Set the voltage at which the device turns on with a resistive voltage-divider connected from $V_{\text{IN}}$ to $\text{SGND}$. Connect the center node of the divider to $\text{EN/UVLO}$. Choose $R_1$ to be $3.3\,M\Omega$ and then calculate $R_2$ as follows:

$$R_2 = \frac{R_1 \times 1.215}{(V_{\text{INU}} - 1.215)}$$

where $V_{\text{INU}}$ is the voltage at which the device is required to turn on. Ensure that $V_{\text{INU}}$ is higher than $0.8 \times V_{\text{OUT}}$.

If the $\text{EN/UVLO}$ pin is driven from an external signal source, a series resistance of minimum $1\,k\Omega$ is recommended to be placed between the signal source output and the $\text{EN/UVLO}$ pin, to reduce voltage ringing on the line.

Loop Compensation

The device is internally loop-compensated. However, if the switching frequency is less than $500\,kHz$, connect a $0.0402\,\mu F$ capacitor $C_6$ between the $\text{CF}$ pin and the $\text{FB}$ pin. Use Table 2 to select the value of $C_6$.

If the switching frequency is less than $200\,kHz$, connect an additional R-C network in parallel to the top resistor of the feedback divider ($R_3$). See Figure 5 to calculate the values of the components $R_7$, $C_{12}$, and $C_6$.

Adjusting Output Voltage

Set the output voltage with a resistive voltage-divider connected from the positive terminal of the output capacitor ($V_{\text{OUT}}$) to $\text{SGND}$ (see Figure 3). Connect the center node of the divider to the $\text{FB}$ pin. Use the following procedure to choose the resistive voltage-divider values:

1. Calculate resistor $R_3$ from the output to the $\text{FB}$ pin as follows:

$$R_3 = \frac{216 \times 10^3}{(f_C \times C_{\text{OUT}})}$$

where $R_3$ is in $k\Omega$, crossover frequency $f_C$ is in $kHz$, and the output capacitor ($C_{\text{OUT}}$) is in $\mu F$. Choose $f_C$ to be $1/9$th of the switching frequency ($f_{\text{SW}}$) if the switching frequency is less than or equal to $500\,kHz$. If the switching frequency is more than $500\,kHz$, select $f_C$ to be $55kHz$.

2. Calculate resistor $R_4$ from the $\text{FB}$ pin to $\text{SGND}$ as follows:

$$R_4 = \frac{R_3 \times 0.9}{(V_{\text{OUT}} - 0.9)}$$

Power Dissipation

At a particular operating condition, the power losses that lead to temperature rise of the part are estimated as follows:

$$P_{\text{LOSS}} = (P_{\text{OUT}} \times \frac{1}{\eta}) - (I_{\text{OUT}}^2 \times R_{\text{DCR}})$$

$$P_{\text{OUT}} = V_{\text{OUT}} \times I_{\text{OUT}}$$

where $P_{\text{OUT}}$ is the total output power, $\eta$ is the efficiency of the converter, and $R_{\text{DCR}}$ is the DC resistances of the inductor. (See the Typical Operating Characteristics for more information on efficiency at typical operating conditions.)

For a multilayer board, the thermal performance metrics for the package are given below:

$$\theta_{JA} = 33^\circ\text{C/W}$$

$$\theta_{JC} = 2^\circ\text{C/W}$$
The junction temperature of the device can be estimated at any given maximum ambient temperature \( T_{A_{\text{MAX}}} \) from the equation below:

\[
T_{J_{\text{MAX}}} = T_{A_{\text{MAX}}} + (\theta \times JA \times P_{\text{LOSS}})
\]

If the application has a thermal management system that ensures that the exposed pad of the device is maintained at a given temperature \( T_{E_{\text{P_MAX}}} \) by using proper heatsinks, then the junction temperature of the device can be estimated at any given maximum ambient temperature from the equation below:

\[
T_{J_{\text{MAX}}} = T_{E_{\text{P_MAX}}} + (\theta \times JC \times P_{\text{LOSS}})
\]

Junction temperature greater than +125°C degrades operating lifetimes.

**PCB Layout Guidelines**

All connections carrying pulsed currents must be very short and as wide as possible. The inductance of these connections must be kept to an absolute minimum due to the high \( \text{di/dt} \) of the currents. Since inductance of a current carrying loop is proportional to the area enclosed by the loop, if the loop area is made very small, inductance is reduced. Additionally, small-current loop areas reduce radiated EMI.

A ceramic input filter capacitor should be placed close to the \( V_{\text{IN}} \) pins of the IC. This eliminates as much trace inductance effects as possible and gives the IC a cleaner voltage supply. A bypass capacitor for the \( V_{\text{CC}} \) pin also should be placed close to the pin to reduce effects of trace impedance.

When routing the circuitry around the IC, the analog small-signal ground and the power ground for switching currents must be kept separate. They should be connected together at a point where switching activity is at a minimum, typically the return terminal of the \( V_{\text{CC}} \) bypass capacitor. This helps keep the analog ground quiet. The ground plane should be kept continuous/unbroken as far as possible. No trace carrying high switching current should be placed directly over any ground plane discontinuity.

PCB layout also affects the thermal performance of the design. A number of thermal vias that connect to a large ground plane should be provided under the exposed pad of the part, for efficient heat dissipation.

For a sample layout that ensures first pass success, refer to the MAX17543 evaluation kit layout available at www.maximintegrated.com.
MAX17543

4.5V–42V, 2.5A, High-Efficiency, Synchronous Step-Down DC-DC Converter with Internal Compensation

Typical Application Circuits

![Circuit Diagram](image)

- **Figure 4a** - 5V Output, 500kHz Switching Frequency
- **Figure 4b** - 3.3V Output, 500kHz Switching Frequency

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Note: All devices operate over the -40ºC to +125ºC temperature range, unless otherwise noted.

+Denotes a lead(Pb)-free/RoHS-compliant package.

*EP = Exposed pad.

Chip Information
PROCESS: BICMOS

Ordering Information

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Note: All devices operate over the -40ºC to +125ºC temperature range, unless otherwise noted.
+Denotes a lead(Pb)-free/RoHS-compliant package.
*EP = Exposed pad.

Package Information
For the latest package outline information and land patterns (footprints), go to www.maximintegrated.com/packages. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

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*EP = Exposed pad.
MAX17543: 4.5V–42V, 2.5A, High-Efficiency, Synchronous Step-Down DC-DC Converter with Internal Compensation

Revision History

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<tr>
<td>0</td>
<td>9/14</td>
<td>Initial release</td>
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<tr>
<td>1</td>
<td>7/16</td>
<td>Updated operating and junction temperature values, added new TOC and text</td>
<td>1–9, 15, 16</td>
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For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim Integrated’s website at www.maximintegrated.com.

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